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#### T-1 (3mm) SOLID STATE LAMP

Part Number: WP710A10QBC/G Blue



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES** 

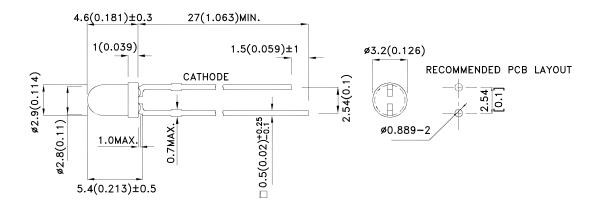
#### **Features**

- Low power consumption.
- Popular T-1 diameter package.
- General purpose leads.
- Reliable and rugged.
- Long life solid state reliability.
- Available on tape and reel.
- RoHS compliant.

#### **Descriptions**

- The Blue source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

#### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
  4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAL0522 **REV NO: V.4B DATE: AUG/28/2014** PAGE: 1 OF 6 CHECKED: Allen Liu **APPROVED: WYNEC** DRAWN: Y.Liu ERP: 1101029215

#### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
WP710A10QBC/G	Blue (InGaN)	Water Clear	1400	2800	20°

#### Notes:

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.
- 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	461		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue	465		nm	I=20mA
Δλ1/2	Spectral Line Half-width	Blue	25		nm	IF=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue	3.3	4	V	IF=20mA
lR	Reverse Current	Blue		50	uA	V <sub>R</sub> = 5V

### Notes:

- 1.Wavelength: +/-1nm. 2.Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4.Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

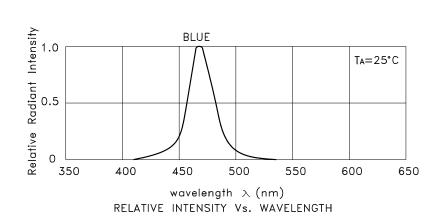
#### Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		
Lead Solder Temperature [2]	260°C For 3 Seconds		
Lead Solder Temperature [3]	260°C For 5 Seconds		

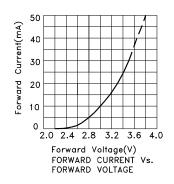
#### Notes:

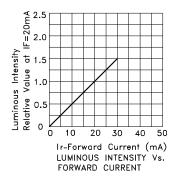
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.
- 3. 5mm below package base.

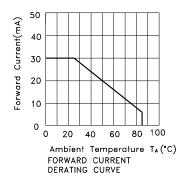
**REV NO: V.4B** DATE: AUG/28/2014 **SPEC NO: DSAL0522** PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.Liu ERP: 1101029215

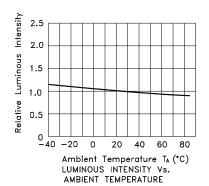


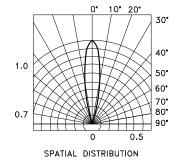
#### Blue WP710A10QBC/G



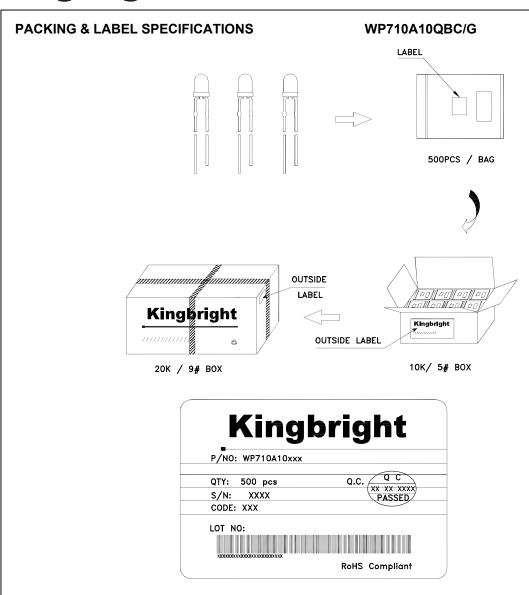








SPEC NO: DSAL0522 REV NO: V.4B DATE: AUG/28/2014 PAGE: 3 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029215



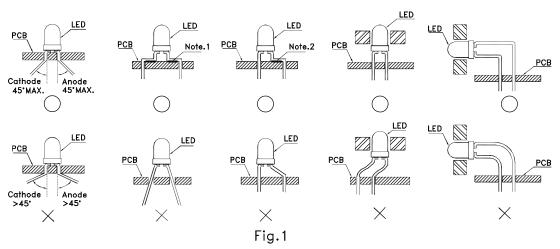
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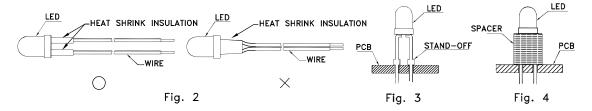
SPEC NO: DSAL0522 REV NO: V.4B DATE: AUG/28/2014 PAGE: 4 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029215

#### **PRECAUTIONS**

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



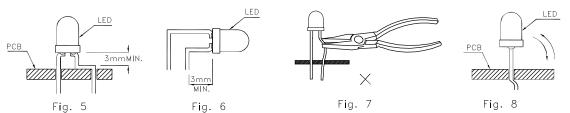
- "( )" Correct mounting method "imes" Incorrect mounting method
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3. Use stand—offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



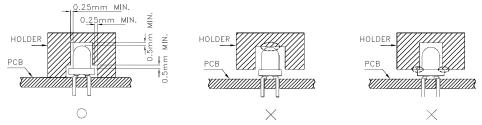
- 4. Maintain a minimum of 3mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

SPEC NO: DSAL0522 APPROVED: WYNEC REV NO: V.4B CHECKED: Allen Liu DATE: AUG/28/2014 DRAWN: Y.Liu PAGE: 5 OF 6 ERP: 1101029215

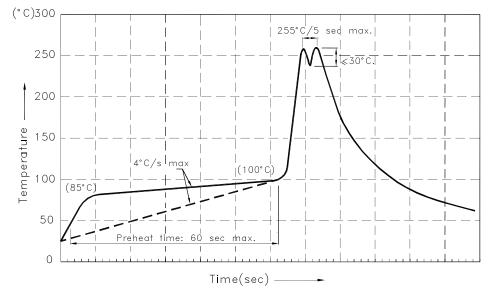
6. Do not bend the leads more than twice. (Fig. 8)



7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- 8. The tip of the soldering iron should never touch the lens epoxy.
- 9. Through—hole LEDs are incompatible with reflow soldering.
- 10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 11. Recommended Wave Soldering Profiles:



#### Notes:

- 1.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C  $\sim$  255°C for 3 sec (5 sec max).
- $3.\mbox{Do}$  not apply stress to the epoxy resin while the temperature is above  $85^{\circ}\mbox{C}.$
- 4.Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.

6.No more than one wave soldering pass.

SPEC NO: DSAL0522 REV NO: V.4B DATE: AUG/28/2014 PAGE: 6 OF 6
APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.Liu ERP: 1101029215